

**HIGH FREQUENCY HALF-BRIDGE GATE DRIVER  
WITH PROGRAMMABLE DEADTIME IN W-DFN3030-10**

## Description

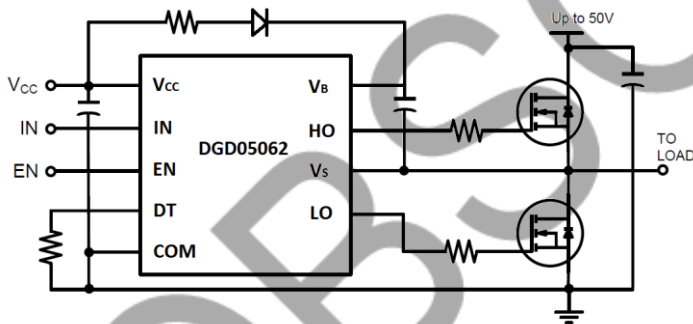
The DGD05062 is a high-frequency half-bridge gate driver capable of driving N-channel MOSFETs in a half-bridge configuration. The floating high-side driver is rated up to 50V.

The DGD05062 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with MCUs. UVLO for high-side and low-side will protect a MOSFET with loss of supply. To protect MOSFETs, cross conduction prevention logic prevents the HO and LO outputs being on at the same time.

Fast and well-matched propagation delays allow a higher switching frequency, enabling a smaller, more compact power switching design using smaller associated components. The DGD05062 is offered in the W-DFN3030-10 package and operates over an extended -40°C to +125°C temperature range.

## Applications

- DC-DC Converters
- Motor Controls
- Battery Powered Hand Tools
- eCig Devices
- Class D Power Amplifiers




Typical Configuration

## Features

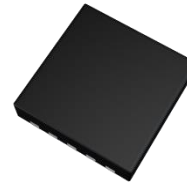
- 50V Floating High-side Driver
- Drives Two N-channel MOSFETs in a Half-bridge Configuration
- 1.25A Source / 2.0A Sink Output Current Capability
- Undervoltage Lockout for High-side and Low-side Drivers
- Programmable Deadtime to Protect MOSFETs
- Logic Input (IN and EN) 3.3V Capability
- Ultra Low Standby Currents (<1µA)
- Extended Temperature Range: -40°C to +125°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.**

<https://www.diodes.com/quality/product-definitions/>

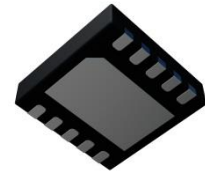
## Mechanical Data

- Case: W-DFN3030-10 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish – Matte Tin Finish. Solderable per MIL-STD-202, Method 208 
- Weight: 0.017 grams (Approximate)

W-DFN3030-10



Top View



Bottom View

## Ordering Information (Note 4)

Part Number	Marking Code	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD05062FN-7	DGD05062	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

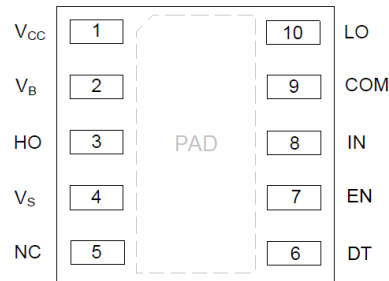
## Marking Information

YYWW  
DGD05062



DGD05062 = Product Type Marking Code  
YY = Year (ex: 21 = 2021)  
WW = Week (01 to 53)

## Pin Diagrams

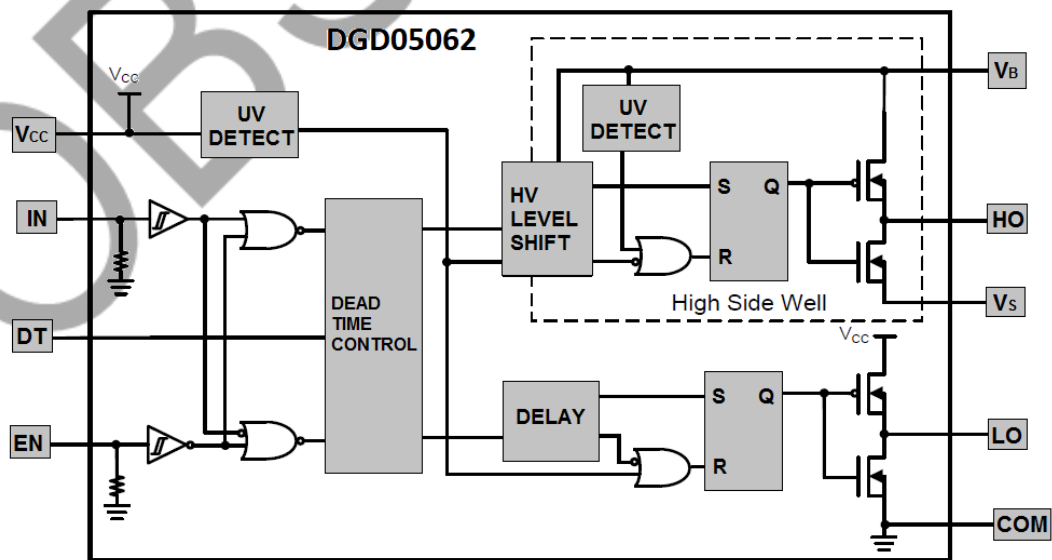


Top View: W-DFN3030-10

## Pin Descriptions

Pin Number	Pin Name	Function
1	V <sub>CC</sub>	Low-Side and Logic Supply
2	V <sub>B</sub>	High-Side Floating Supply
3	HO	High-Side Gate Drive Output
4	V <sub>S</sub>	High-Side Floating Supply Return
5	NC	No connection (No Internal Connection)
6	DT	Deadtime Control
7	EN	Logic Input Enable, a Logic Low turns off Gate Driver
8	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
9	COM	Low-Side and Logic Return
10	LO	Low-Side Gate Drive Output
PAD	Substrate	Connect to COM on PCB

## Functional Block Diagram



**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Positive Supply Voltage	V <sub>B</sub>	-0.3 to +50	V
High-Side Floating Negative Supply Voltage	V <sub>S</sub>	V <sub>B</sub> -14 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Logic and Low-Side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +15	V
Low-Side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (IN and EN)	V <sub>IN</sub>	-0.3 to +15	V

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P <sub>D</sub>	0.4	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	64	°C/W
Thermal Resistance, Junction to Case (Note 5)	R <sub>θJC</sub>	42	°C/W
Operating Temperature	T <sub>J</sub>	+150	°C
Lead Temperature (Soldering, 10s)	T <sub>L</sub>	+300	
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

**Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply	V <sub>B</sub>	V <sub>S</sub> + 8	V <sub>S</sub> + 14	V
High-Side Floating Supply Offset Voltage	V <sub>S</sub>	(Note 6)	50 (Note 7)	V
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub>	V <sub>B</sub>	V
Logic and Low Side Fixed Supply Voltage	V <sub>CC</sub>	8	14	V
Low-Side Output Voltage	V <sub>LO</sub>	0	V <sub>CC</sub>	V
Logic Input Voltage (IN and EN)	V <sub>IN</sub>	0	5	V
Ambient Temperature	T <sub>A</sub>	-40	+125	°C

Notes: 6. Logic operation for V<sub>S</sub> of -5V to +50V. Logic state held for V<sub>S</sub> of -5V to -V<sub>BS</sub>.

7. Provided V<sub>B</sub> doesn't exceed absolute maximum rating of 50V.

**DC Electrical Characteristics** ( $V_{CC} = V_{BS} = 12V$ ,  $COM = V_S = 0V$ ,  $@T_A = +25^\circ C$ , unless otherwise specified.) (Note 8)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Logic "1" Input Voltage	$V_{IH}$	2.4	—	—	V	—
Logic "0" Input Voltage	$V_{IL}$	—	—	0.8	V	—
Enable Logic "1" Input Voltage	$V_{ENIH}$	1.5	—	—	V	—
Enable Logic "0" Input Voltage	$V_{ENIL}$	—	—	0.7	V	—
Input Voltage Hysteresis	$V_{INHYS}$	—	0.6	—	V	—
High Level Output Voltage, $V_{BIAS} - V_O$	$V_{OH}$	—	0.45	0.6	V	$I_{O+} = 100mA$
Low Level Output Voltage, $V_O$	$V_{OL}$	—	0.15	0.22	V	$I_{O-} = 100mA$
Offset Supply Leakage Current	$I_{LK}$	—	10	50	$\mu A$	$V_B = V_S = 50V$
$V_{CC}$ Shutdown Supply Current	$I_{CCSD}$	—	0	1	$\mu A$	$V_{IN} = 0V$ or $5V$ , $V_{EN} = 0V$
$V_{CC}$ Quiescent Supply Current	$I_{CCQ}$	—	0.32	0.5	mA	$V_{IN} = 0V$ or $5V$ , $R_{DT} = 100k\Omega$
$V_{CC}$ Operating Supply Current	$I_{CCOP}$	—	2.1	—	mA	$f_s = 500kHz$
$V_{BS}$ Quiescent Supply Current	$I_{BSQ}$	—	62	100	$\mu A$	$V_{IN} = 0V$ or $5V$
$V_{BS}$ Operating Supply Current	$I_{BSOP}$	—	1.1	—	mA	$f_s = 500kHz$
Logic "1" Input Bias Current	$I_{IN+}$	—	25	60	$\mu A$	$V_{IN} = 5V$
Logic "0" Input Bias Current	$I_{IN-}$	—	0	1	$\mu A$	$V_{IN} = 0V$
$V_{BS}$ Supply Undervoltage Positive Going Threshold	$V_{BSUV+}$	5.9	6.9	7.9	V	—
$V_{BS}$ Supply Undervoltage Negative Going Threshold	$V_{BSUV-}$	5.6	6.6	7.6	V	—
$V_{CC}$ Supply Undervoltage Positive Going Threshold	$V_{CCUV+}$	5.9	6.9	7.9	V	—
$V_{CC}$ Supply Undervoltage Negative Going Threshold	$V_{CCUV-}$	5.6	6.6	7.6	V	—
Output High Short Circuit Pulsed Current	$I_{O+}$	0.9	1.25	—	A	$V_O = 0V$ , $PW \leq 10\mu s$
Output Low Short Circuit Pulsed Current	$I_{O-}$	1.5	2.0	—	A	$V_O = 15V$ , $PW \leq 10\mu s$

Note: 8. The  $V_{IN}$  and  $I_{IN}$  parameters are applicable to the two logic pins: IN and EN. The  $V_O$  and  $I_O$  parameters are applicable to the respective output pins: HO and LO.

**AC Electrical Characteristics** ( $V_{CC} = V_{BS} = 12V$ ,  $COM = V_S = 0V$ ,  $C_L = 1000pF$ ,  $@T_A = +25^\circ C$ , unless otherwise specified.)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Turn-on Propagation Delay, HO & LO	$t_{ON}$	65	96	125	ns	$R_{DT} = 10k\Omega$
		350	463	580	ns	$R_{DT} = 100k\Omega$
Turn-off Propagation Delay, HO & LO	$t_{OFF}$	—	22	56	ns	—
Turn-on Rise Time	$t_r$	—	17	35	ns	—
Turn-off Fall Time	$t_f$	—	12	25	ns	—
Delay Matching	$t_{DM}$	—	—	50	ns	—
Deadtime: $t_{DT LO-HO}$ & $t_{DT HO-LO}$	$t_{DT}$	40	70	100	ns	$R_{DT} = 10k\Omega$
		300	430	560	ns	$R_{DT} = 100k\Omega$
Deadtime Matching	$t_{MDT}$	—	—	50	ns	$R_{DT} = 100k\Omega$

## Timing Waveforms

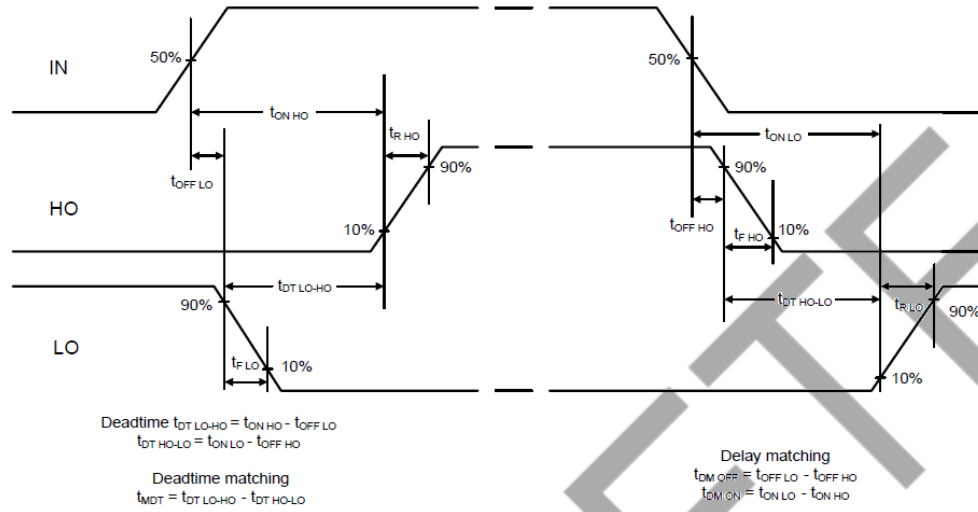


Figure 1. Switching Time Waveform Definitions

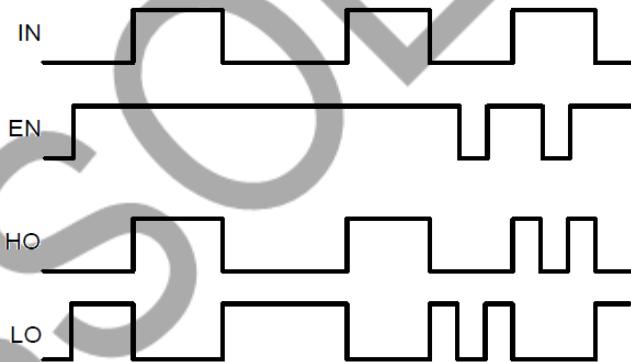
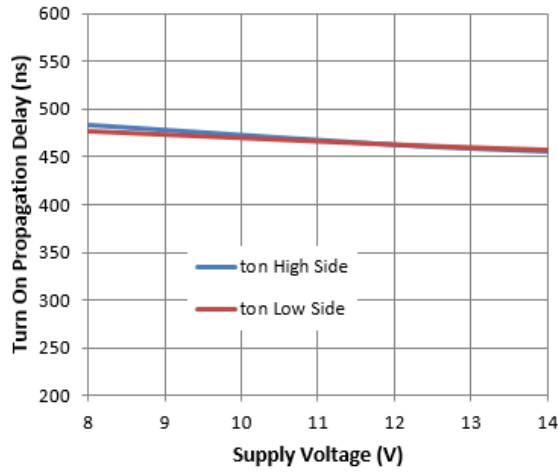
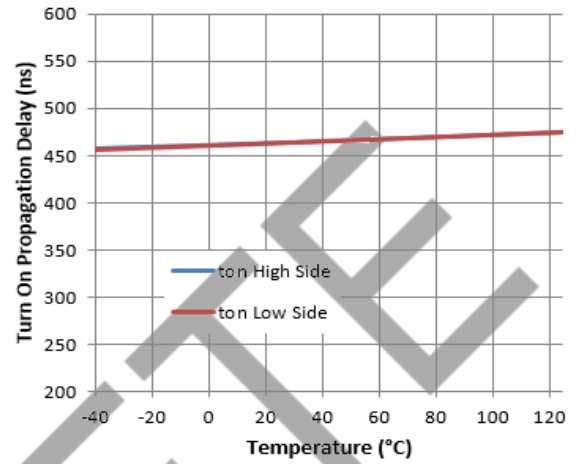


Figure 2. Input / Output Timing Diagram

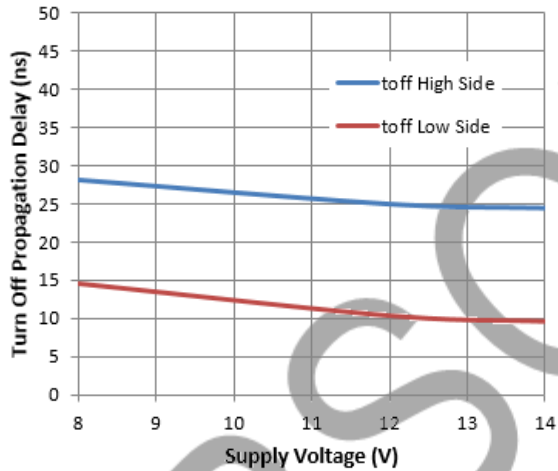
**Typical Performance Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



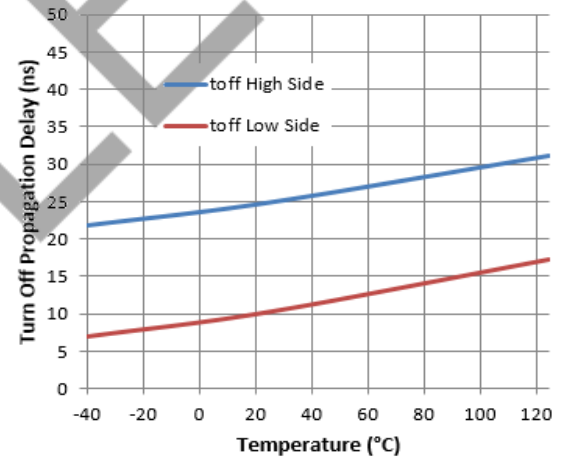
Turn-on Propagation Delay vs. Supply Voltage



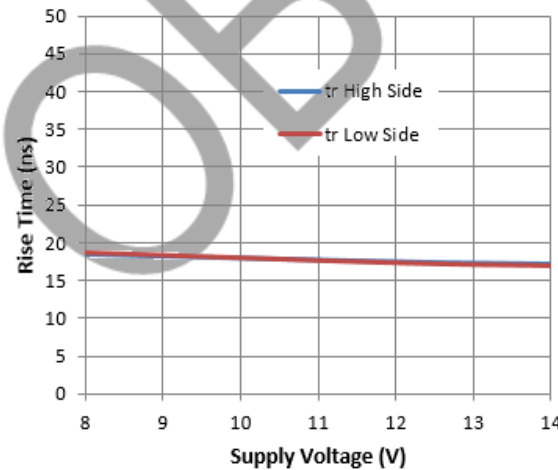
Turn-on Propagation Delay vs. Temperature



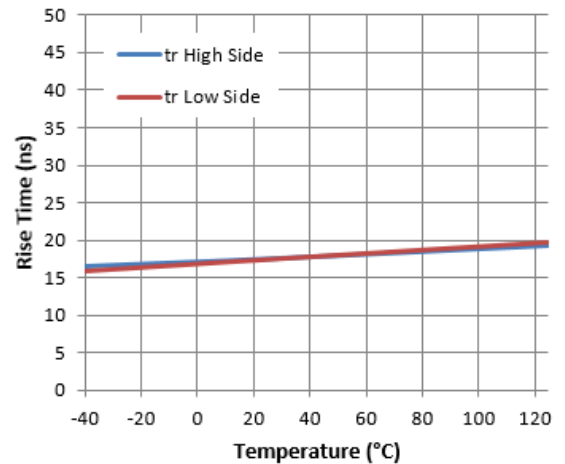
Turn-off Propagation Delay vs. Supply Voltage



Turn-off Propagation Delay vs. Temperature

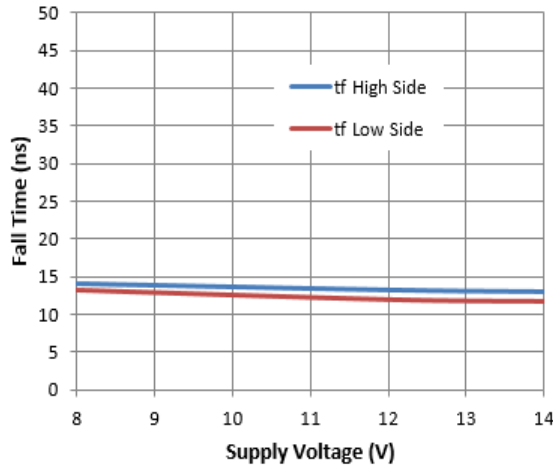


Rise Time vs. Supply Voltage

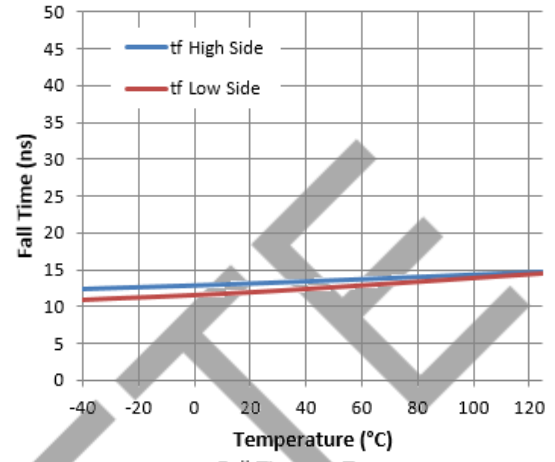


Rise Time vs. Temperature

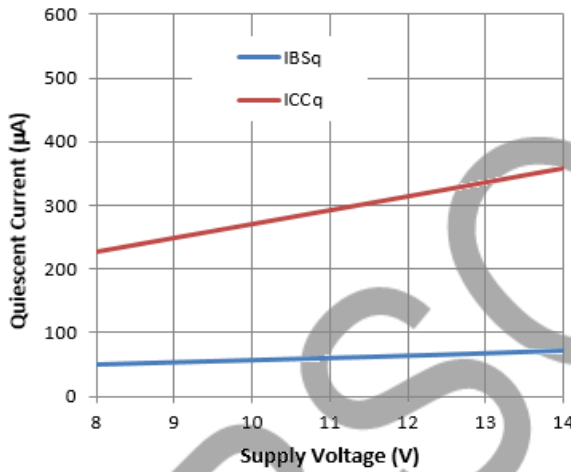
# Typical Performance Characteristics (continued)



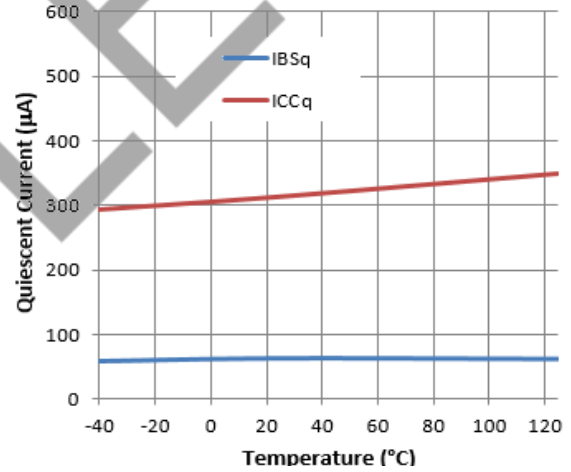
Fall Time vs. Supply Voltage



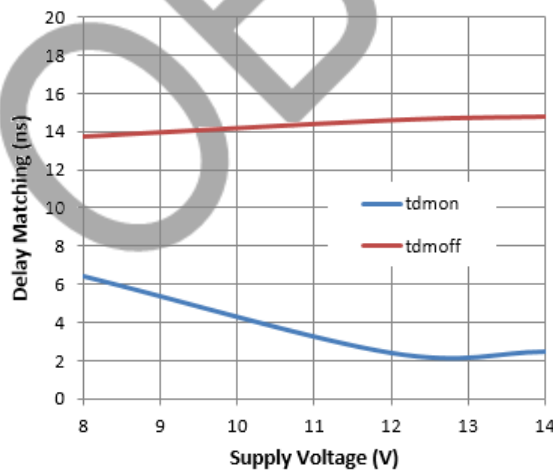
Fall Time vs. Temperature



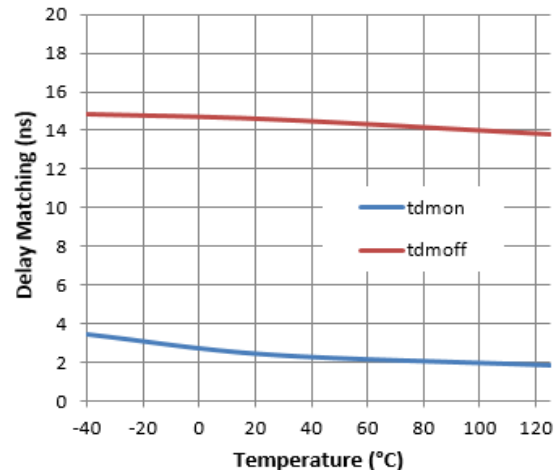
Quiescent Current vs. Supply Voltage



Quiescent Current vs. Temperature

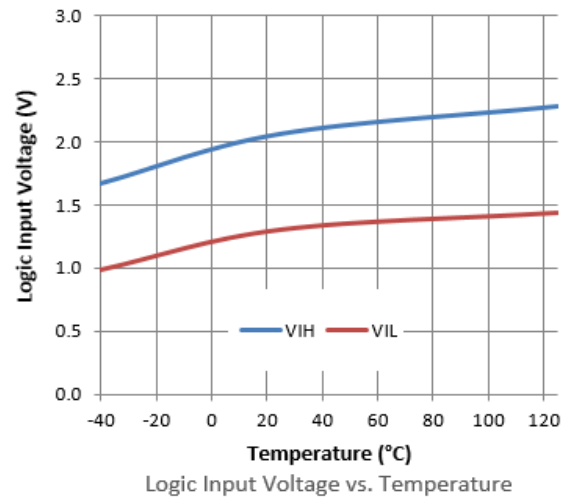
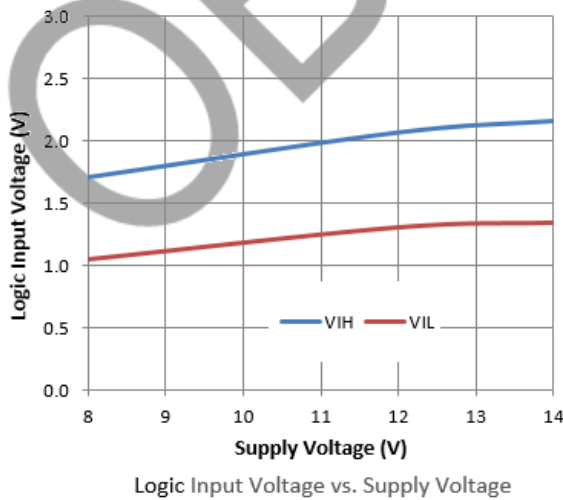
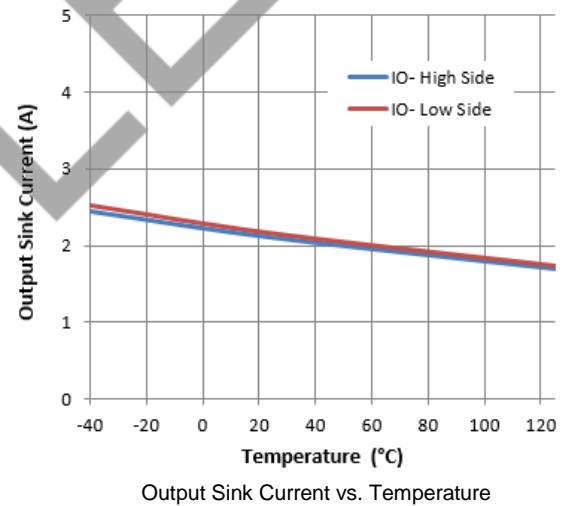
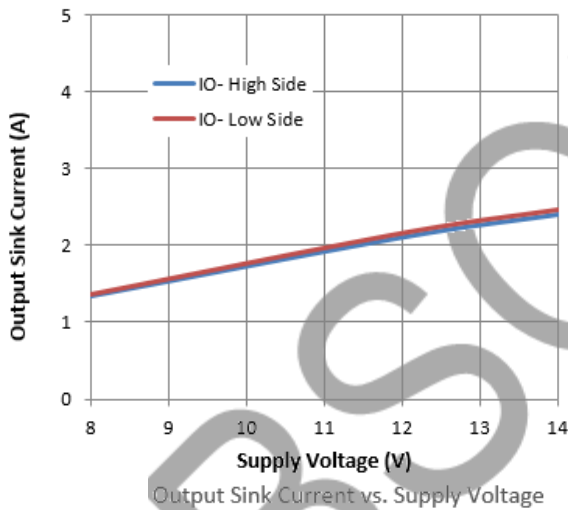
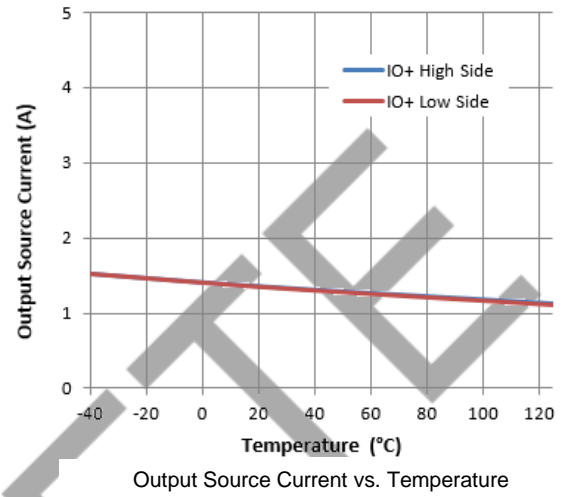
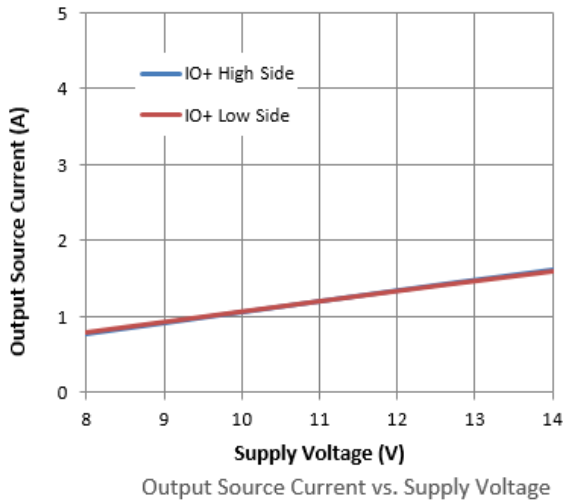


Delay Matching vs. Supply Voltage



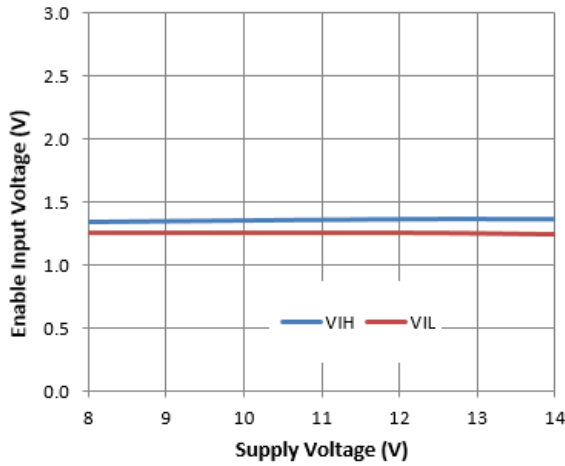
Delay Matching vs. Temperature

## Typical Performance Characteristics (continued)

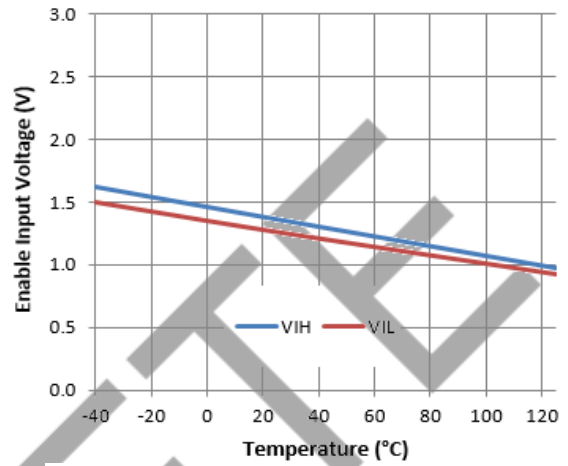




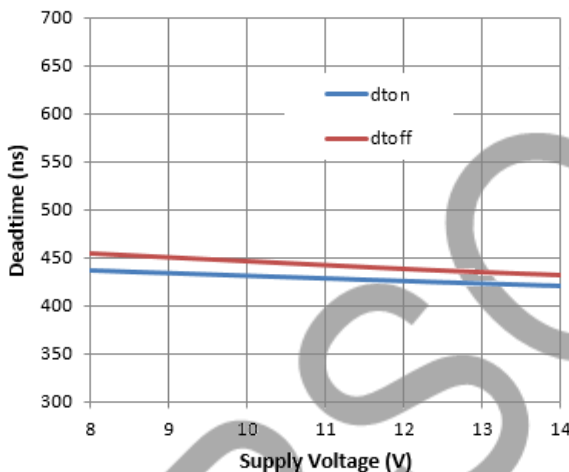
# Typical Performance Characteristics (continued)



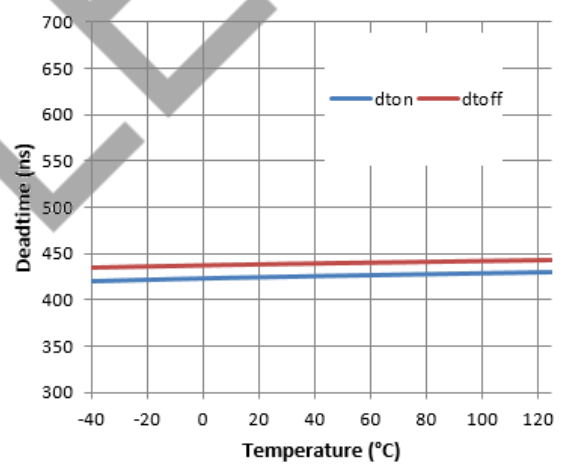
Enable Input Voltage vs. Supply Voltage



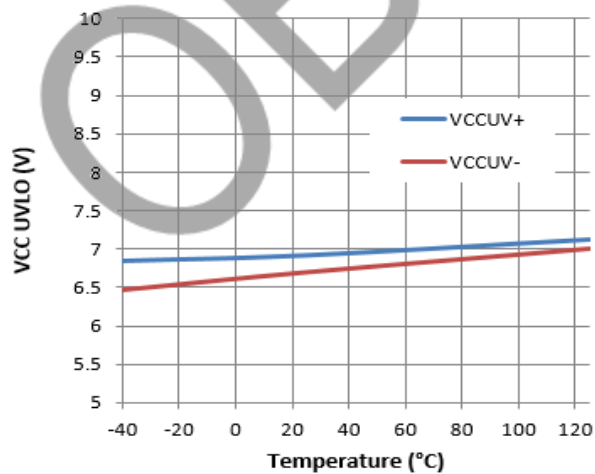
Enable Input Voltage vs. Temperature



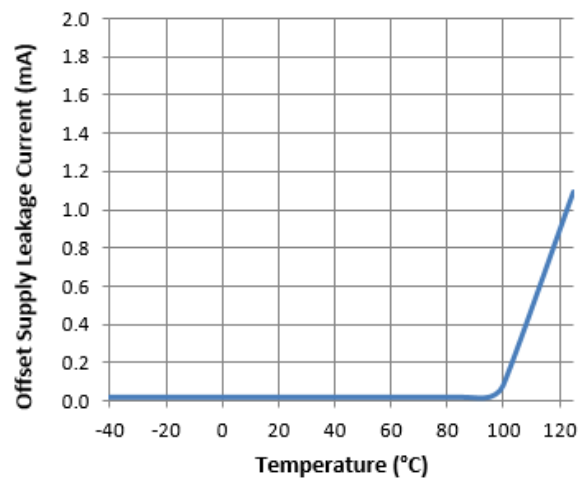
Deadtime vs. Supply Voltage



Deadtime vs. Temperature



VCC UVLO vs. Temperature



Offset Supply Leakage Current vs. Temperature

## Application Information

### Bootstrap Capacitor Selection

The capacitance of the bootstrap capacitor should be high enough to provide the charge required by the gate of the high side MOSFET with only a minimal loss of voltage across it. As a general guideline, it is recommended to make sure the charge stored by the bootstrap capacitor is about 50 times more than the required gate charge at operating  $V_{CC}$  (usually about 10V to 12V).

The formula to calculate the change in  $V_{BS}$  to provide a certain amount of gate charge is shown below;

$Q = C * V$  where  $Q$  is the gate charge required by the external MOSFET to raise its gate voltage to 10V.  $C$  is the bootstrap capacitance and  $V$  is the voltage drop across the  $V_{BS}$ .

Example: To switch a high side MOSFET that requires 20nC of gate charge to raise its gate voltage to 10V, the capacitor size can be calculated as below;

$$Q_{G(MOSFET)} = C_{(BOOTSTRAP)} * \Delta V_{BS};$$

$\Delta V_{BS}$  = voltage drop across the bootstrap capacitor while providing the required gate charge.

In this example, let's say the acceptable  $\Delta V_{BS}$  is 200mV.

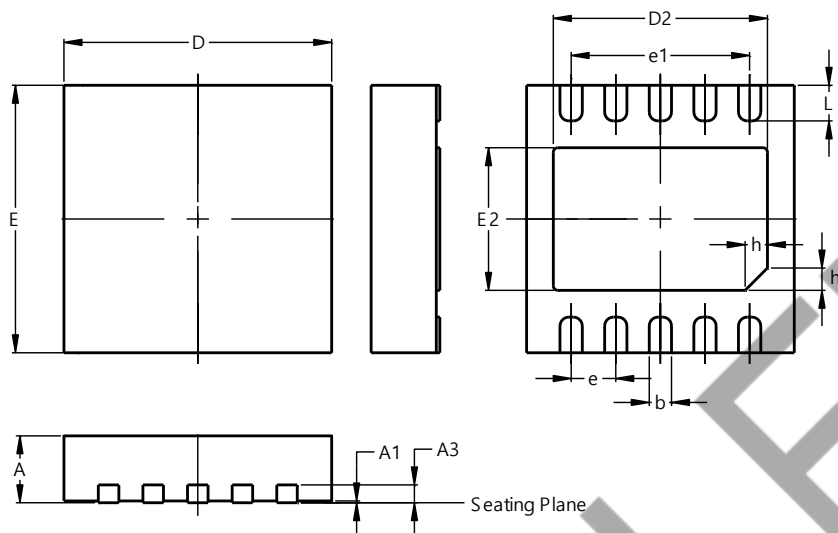
The required bootstrap capacitor for the job is;

$$C_{(BOOTSTRAP)} = Q_{G(MOSFET)} / \Delta V_{BS} = 20nC / 200mV = 100nF$$

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

W-DFN3030-10 (Type TH)

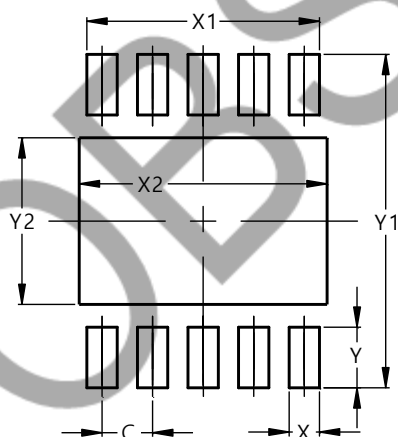


W-DFN3030-10 (Type TH)			
Dim	Min	Max	Typ
A	0.70	0.80	0.75
A1	--	0.05	0.02
A3	0.18	0.25	0.20
b	0.18	0.30	0.25
D	2.90	3.10	3.00
D2	2.40	2.60	2.50
e	0.50BSC		
e1	2.00BSC		
E	2.90	3.10	3.00
E2	1.45	1.65	1.55
h	0.20	0.30	0.25
L	0.30	0.50	0.40
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

W-DFN3030-10 (Type TH)



Dimensions	Value (in mm)
C	0.500
X	0.300
X1	2.300
X2	2.600
Y	0.600
Y1	3.300
Y2	1.650

Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.

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